

Features

- 3.6*3.1*3.5 mm SMD LED
- High Brightness
- InGaN Technology
- Viewing Angle 30°
- High reliability
- MSL Level 3
- Water-Resistant(IPX7)

Applications

- Consumer Electronics
- Traffic lights
- Automobile After Market
- Industrial Equipment

Description

The IN-P36ATEG is a popular low profile 3631 package with versatile design capabilities. It is a PLCC type silicone style LED which can be used in various applications.

Recommended Solder Pattern

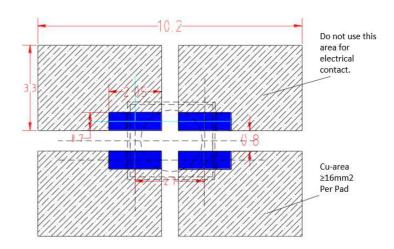


Figure 1. IN-P36ATEG Solder Pattern

Package Dimensions in mm

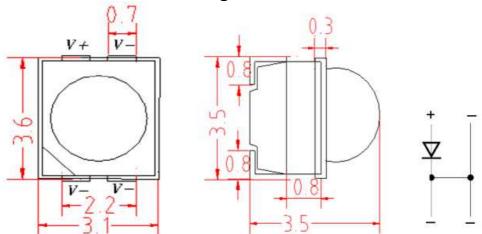


Figure 2. IN-P36ATEG Package Dimensions

*Notice: Tolerance of measurement of Dimension: ±0.2mm



Absolute Maximum Rating at 25°C

Product	Emission Color	P _d (mW)	I _{FP} * (mA)	T _j (°C)	V _R (V)	Top (°C)	Тsт (°С)
IN-P36ATEG	Green	95	80	125	5	-40°C~+100°C	-40°C~+100°C

^{*}Condition for IFP is pulse of 1/10 duty and 0.1msec width

ESD Precaution

ATTENTION: Electrostatic Discharge (ESD) protection



The symbol above denotes that ESD precaution is needed. ESD protection for GaP and AlGaAs based chips is necessary even though they are relatively safe in the presence of low static-electric discharge. Parts built with AllnGaP, GaN, or/and InGaN based chips are STATIC SENSITIVE devices. ESD precaution must be taken during design and assembly. If manual work or processing is needed, please ensure the device is adequately protected from ESD during the process.

Please be advised that normal static precautions should be taken in the handling and assembly of this device to prevent damage or degradation which may be induced by electrostatic discharge (ESD).

Electrical Characteristics $T_A = 25\%$

				V _F (V)	Luminous	λ(nm)	Viewing	lr	ESD
D l		Emission		* (*)	Intensity(mcd)	λ(ι)	Angle	(Vr = 5V)	Sensitivity(V)
Produc	CT	Color	I _F (mA)	Тур.	Тур.	λ D	2 <i>\theta</i> 1/2	μΑ	НВМ
IN-P36A7	ΓEG	Green	30	3.0	11000	522.5	30	10	1000

^{*}Notes: Performance guaranteed only under conditions listed in above tables.



Luminous Intensity Rank Limits (IF =30mA)

Bin Code	35	36	37	38
Flux Rank(mcd)	6600-8600	8600-11200	11200-14600	14600-19000

^{*}Notice: Tolerance of measurement of Luminous Intensity: ±12%

Forward Voltage Rank Limits (IF =30mA)

Bin Code	Min	Max	Unit
V2B	2.4	2.7	
V2C	2.7	3.0	
V3A	3.0	3.3	V
V3B	3.3	3.6	

^{*}Notice: Tolerance of measurement of Forward Voltage: ±0.1V

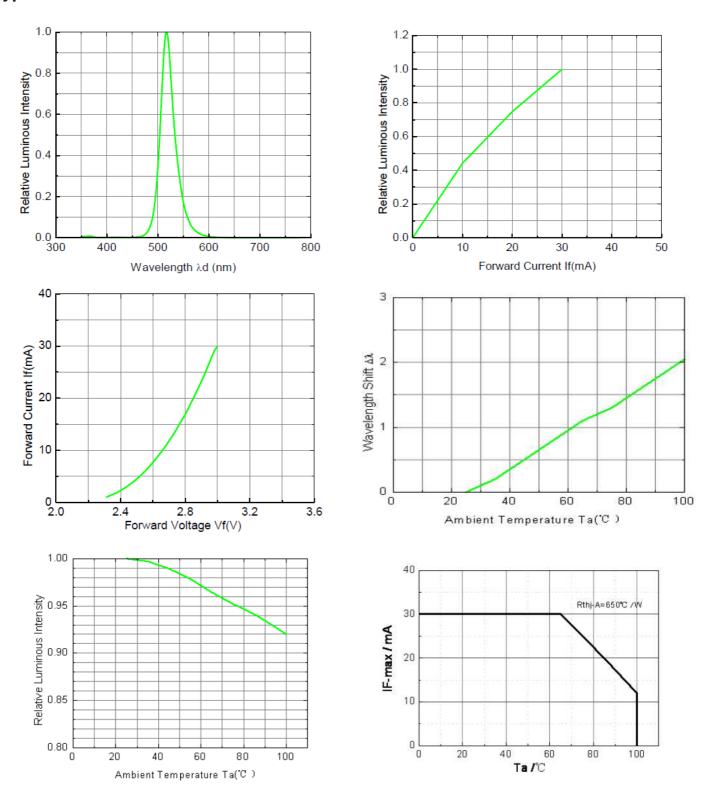
Dominant Wavelength Rank Limits (IF =30mA)

Bin Code	Min	Max	Unit
TG1	515	520	
TG2	520	525	nm
TG3	525	530	

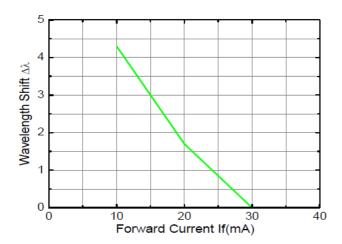
^{*}Notice: Tolerance of measurement of Dominant Wavelength: ±1nm

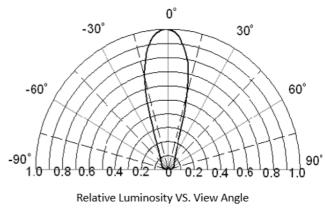


Typical Characteristic Curves







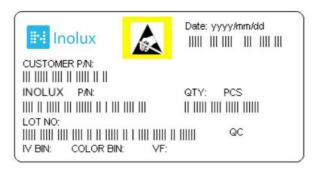


Ordering Information

Product	Emission Color	Technology	Test Current I _F (mA)	Luminous Intensity I _V (mcd) (Typ.)	Forward Voltage V _F (V) (Typ.)	Orderable Part Number
IN-P36ATEG	Green	InGaN	30	11000	3.0	IN-P36ATEG



Label Specifications



Inolux P/N:

I	N	-	Р	3	6	Α	Т	E		G	-	Χ	Х	Х	Х
			Material	Pack	age	Variation	Orientation	Current	Lens	Color			usto Stam		
Inc	olux		P = PLCC Type	36A =	3.6 x 3. (30 D	.1 x 3.5mm eg)	T = Top Mount	E = 30mA	(Blank) = Clear U = Diffused	G=520nm					

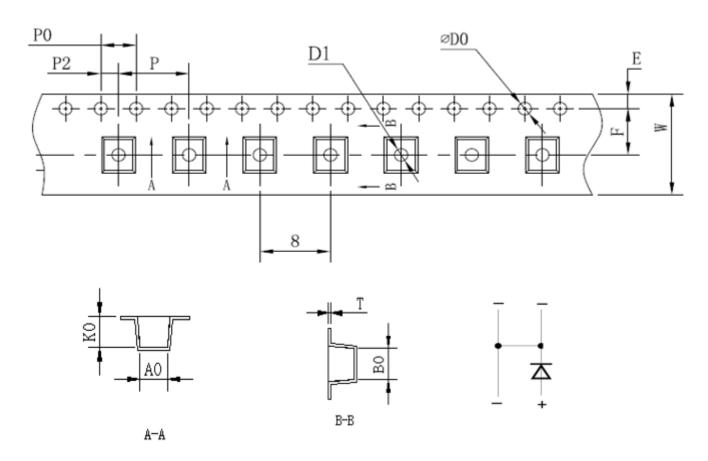
Lot No.:

Z	2	0	1	7	01	24	001
Internal		Voor (2017	2019 \		Month	Data	Sorial
Tracker		Teal (2017	, 2018,)		ivionth	Date	Serial



Packaging Information: 2000pcs Per Reel

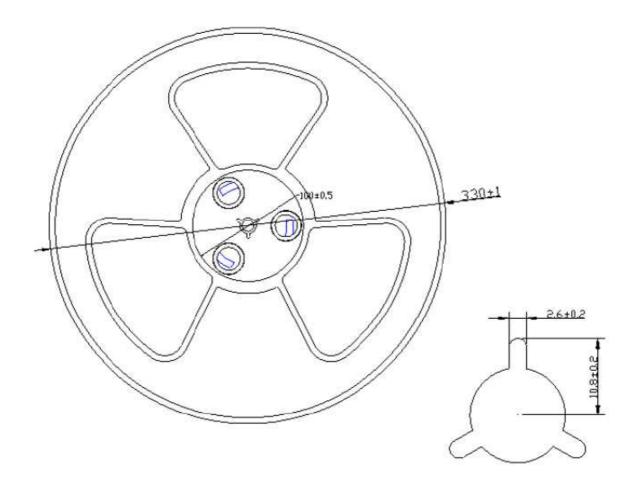
Tape Dimension



Symbol	Α0	В0	K0	P0	Р	P2	Т
Spec	3.2±0.1	3.7±0.1	3.45±0.1	4.0±0.1	8.0±0.1	2.00±0.1	0.3±0.05
Symbol	E	F	D0	D1	w		
Spec	1.75±0.10	5.50±0.05	1.5±0.1	1.5±0.1	12±0.1		



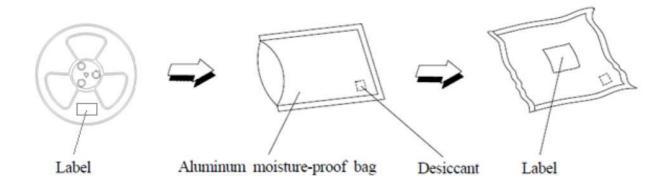
Reel Dimension



Unit: mm



Packing Dimension



	Specification	Material	Quantity
Carrier tape	Per EIA 481-1A specs	Conductive black tape	2000pcs per reel
Reel	Per EIA 481-1A specs	Conductive black	
Label	IN standard	Paper	
Packing bag	220x240mm	Aluminum laminated bag/ no-zipper	One reel per bag
Carton	IN standard	Paper	Non-specified

Others:

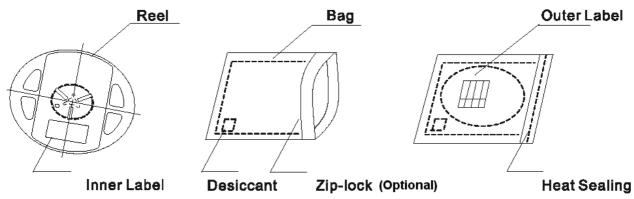
Each immediate box consists of 5 reels. The 5 reels may not necessarily have the same lot number or the same bin combinations of Iv, λ_D and Vf. Each reel has a label identifying its specification; the immediate box consists of a product label as well.

Dry Pack

All SMD optical devices are **MOISTURE SENSITIVE**. Avoid exposure to moisture at all times during transportation or storage. Every reel is packaged in a moisture protected anti-static bag. Each bag is properly sealed prior to shipment.

Upon request, a humidity indicator will be included in the moisture protected anti-static bag prior to shipment.

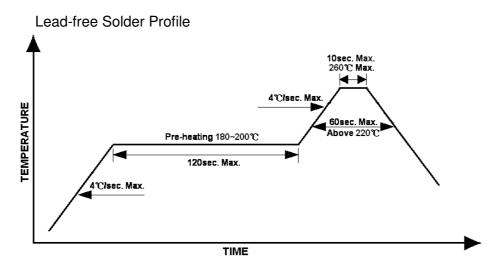
The packaging sequence is as follows:





Reflow Soldering

- Recommended tin glue specifications: melting temperature in the range of 178~192 °C
- The recommended reflow soldering profile is as follows (temperatures indicated are as measured on the surface of the LED resin):



Precautions

- Avoid exposure to moisture at all times during transportation or storage.
- Anti-Static precaution must be taken when handling GaN, InGaN, and AllnGaP products.
- It is suggested to connect the unit with a current limiting resistor of the proper size. Avoid applying a reverse voltage.
- Avoid operation beyond the limits as specified by the absolute maximum ratings.
- Avoid direct contact with the surface through which the LED emits light.
- If possible, assemble the unit in a clean room or dust-free environment.

Reworking

- Rework should be completed within 5 seconds under 260 °C.
- The iron tip must not come in contact with the copper foil.
- Twin-head type is preferred.

Cleaning

Following are cleaning procedures after soldering:

- An alcohol-based solvent such as isopropyl alcohol (IPA) is recommended.
- Temperature x Time should be 50°C x 30sec. or <30°C x 3min
- Ultra sonic cleaning: < 15W/ bath; bath volume ≤ 1liter
- Curing: 100 °C max, <3min

Cautions of Pick and Place

- Avoid stress on the resin at elevated temperature.
- Avoid rubbing or scraping the resin by any object.
- Electro-static may cause damage to the component. Please ensure that the equipment is properly grounded. Use of an ionizer fan is recommended.



Reliability

	Standards	Conditions
	J-STD-020	1.) Baking at 85°C for 24hrs
		2.) Moisture storage at 30°C/ 60% R.H. for
		192hrs
1Q/ 1/ 22/ 0		Accelerated aging 155°C/ 24hrs
	And CNS-5068	Tinning speed: 2.5+0.5cm/s
		Tinning: A: 215°C/ 3+1s or B: 260°C/ 10+1s
	CNS-5067	Dipping soldering terminal only
		Soldering bath temperature
		A: 260+/-5°C; 10+/-1s
		B: 350+/-10°C; 3+/-0.5s
1Q/ 1/ 40/ 0	CNS-11829	1.) Precondition: 85°C baking for 24hrs
		85°C/ 60%R.H. for 168hrs
		2.) Temp=25°C; IF=30mA; duration 1000hrs
1Q/ 1/ 45/ 0	JESD-A101-B	Temp: 85°C
		Humidity: 85% R.H., IF=5mA
		Duration: 1000hrs
1Q/ 1/ 20	IN specs.	Temp: 55°C
		IF=30mA
		Duration: 1000hrs
1Q/ 1/ 40/ 0		Temp=25°C, If=30mA,, Ip=100mA, Duty
		cycle=0.125 (tp=125 μ s,T=1sec)
		Duration 500hrs)
1Q/ 1/ 76/ 0	JESD-A104-A	A cycle: -40 degree C 15min; +85 degree C
	IEC 68-2-14. Nb	15min
	, -	Thermal steady within 5 min
		300 cycles
		2 chamber/ Air-to-air type
1Q/ 1/ 40/ 0	CNS-6117	60+3°C
		90+5/-10% R.H. for 500hrs
1Q/ 1/ 40/ 0	CNS-554	100+10°C for 500hrs
	1	
1Q/ 1/ 40/ 0	CNS-6118	-40+5°C for 500hrs
f	failures For all reliability monitoring tests according to JEDEC Level 3 TQ/ 1/ 22/ 0 TQ/ 1/ 45/ 0 TQ/ 1/ 40/ 0 TQ/ 1/ 76/ 0 TQ/ 1/ 40/ 0 TQ/ 1/ 40/ 0	Reference For all reliability monitoring tests according to JEDEC Level 3 IQ/ 1/ 22/ 0 IQ/ 1/ 22/ 0 JESD22-B102-B And CNS-5068 CNS-5067 IQ/ 1/ 40/ 0 IQ/ 1/ 45/ 0 JESD-A101-B IQ/ 1/ 40/ 0 IQ/ 1/ 76/ 0 JESD-A104-A IEC 68-2-14, Nb IQ/ 1/ 40/ 0 CNS-554



Revision History

Changes since last revision	Page	Version No.	Revision Date
Initial Release		1.0	02-03-2019

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